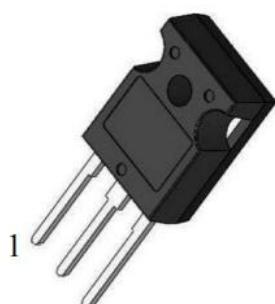
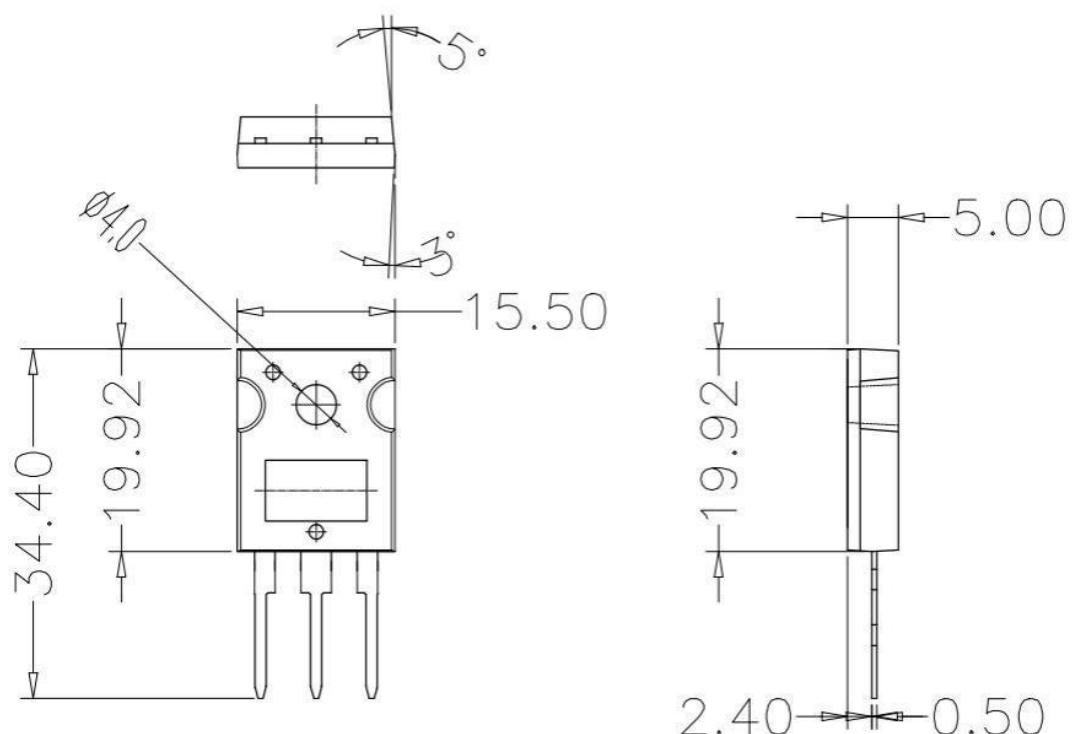
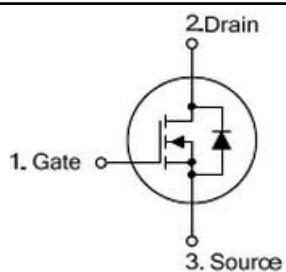


**◆ Features:**

- ◊ Fast switching speed  
开关速度快
- ◊ High input impedance and low level drive  
高输入阻抗和低电平驱动
- ◊ Avalanche energy tested  
雪崩能量测试
- ◊ Improved dv/dt capability, high ruggedness  
提高 dv/dt 能力，高耐用性

**TO-247S****◆ Applications**

- ◊ High efficiency switch mode power supplies  
高效率开关电源
- ◊ Power factor correction  
功率因数校正
- ◊ Electronic lamp ballast  
电子整流器





IXTX90N25L2

250V N-CHANNEL MOSFET

<http://www.osen.net.cn>

## ◆ Absolute Maximum Ratings (Tc=25°C)

Symbol	Parameters	Ratings		Unit
V <sub>DSS</sub>	Drain-Source Voltage 漏源电压	250		V
V <sub>GS</sub>	Gate-Source Voltage-Continuous 栅源电压	±30		V
I <sub>D</sub>	Drain Current-Continuous (Note 2) 漏极持续电流	90		A
I <sub>DM</sub>	Drain Current-Single Plused (Note 1) 漏极单次脉冲电流	360		A
P <sub>D</sub>	Power Dissipation (Note 2) 功率损耗	360		W
T <sub>j</sub>	Max.Operating junction temperature 最大结温	150		°C

## ◆ Electrical characteristics (Tc=25°C unless otherwise noted)

Symbol	Parameters	Min	Typ	Max	Units	Conditions
<b>Static Characteristics</b>						
B <sub>VDSS</sub>	Drain-Source Breakdown VoltageCurrent (Note 1) 漏极击穿电压	250	--	--	V	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V, T <sub>j</sub> =25°C
V <sub>GS(th)</sub>	Gate Threshold Voltage 栅极开启电压	2.0	--	4.0	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA
R <sub>DS(on)</sub>	Drain-Source On-Resistance 漏源导通电阻	--	25	--	mΩ	V <sub>GS</sub> =10V, I <sub>D</sub> =1.0A
I <sub>GSS</sub>	Gate-Body Leakage Current 栅极漏电流	--	--	±100	nA	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0
I <sub>DSS</sub>	Zero Gate Voltage Drain Current 零栅极电压漏极电流	--	--	1	μA	V <sub>DS</sub> =80V, V <sub>GS</sub> =0
g <sub>fS</sub>	Forward Transconductance 正向跨导	--	55	--	S	V <sub>DS</sub> =20V, I <sub>D</sub> =10A



IXTX90N25L2

250V N-CHANNEL MOSFET

Switching Characteristics						
T <sub>d(on)</sub>	Turn-On Delay Time 开启延迟时间	--	<b>50</b>	--	ns	V <sub>DS</sub> =125V, I <sub>D</sub> =45A, R <sub>G</sub> =2.0Ω (Note 2)
T <sub>r</sub>	Rise Time 上升时间	--	<b>180</b>	--	ns	
T <sub>d(off)</sub>	Turn-Off Delay Time 关闭延迟时间	--	<b>45</b>	--	ns	
T <sub>f</sub>	Fall Time 下降时间	--	<b>160</b>	--	ns	
Q <sub>g</sub>	Total Gate Charge 栅极总电荷	--	<b>655</b>	--	nC	
Q <sub>gs</sub>	Gate-Source Charge 栅源极电荷	--	<b>125</b>	--	nC	
Q <sub>gd</sub>	Gate-Drain Charge 栅漏极电荷	--	<b>385</b>	--	nC	
Dynamic Characteristics						
C <sub>iss</sub>	Input Capacitance 输入电容	--	<b>5880</b>	--	pF	V <sub>DS</sub> =25V, V <sub>GS</sub> =0, f=1MHz
C <sub>oss</sub>	Output Capacitance 输出电容	--	<b>2110</b>	--	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance 反向传输电容	--	<b>380</b>	--	pF	
I <sub>S</sub>	Continuous Drain-Source Diode Forward Current (Note 2) 二极管导通正向持续电流	--	--	<b>90</b>	A	
V <sub>SD</sub>	Diode Forward On-Voltage 二极管正向导通电压	--	--	<b>1.2</b>	V	I <sub>S</sub> =1A, V <sub>GS</sub> =0
R <sub>th(j-c)</sub>	Thermal Resistance, Junction to Case 结到外壳的热阻	--	--	<b>0.34</b>	°C/W	
trr	Reverse Recovery Time 反向恢复时间	--	<b>360</b>	--	ns	V <sub>GS</sub> = 0V, I <sub>S</sub> = 90A, dI <sub>F</sub> /dt = 100A /μs

Note 1: Repetitive Rating : Pulse width limited by maximum junction temperature

Note 2: Pulse test: PW <= 300us , duty cycle <= 2%.